



#### High-Speed USB2.0 1:2 Multiplexer/DeMultiplexer Switch with Signal Enable

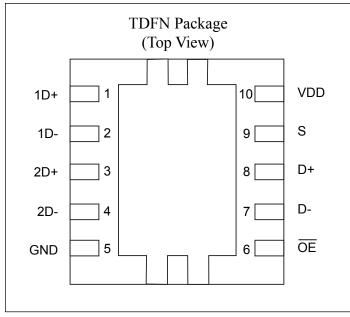
#### Features

- V<sub>DD</sub> Operation at 2.5 V and 3.3 V
- V<sub>I/O</sub> Accepts Signals up to 5.5 V
- 1.8-V Compatible Control-Pin Inputs
- Low-Power Mode When  $\overline{OE}$  Is Disabled (2  $\mu$ A)
- $r_{ON} = 6\Omega$  Maximum
- $\Delta r_{ON} = 0.2\Omega$  Typical
- Cio(on) = 6 pF Maximum
- Low Power Consumption (50 μA Maximum)
- ESD > 8kV contact on USB signal path per IEC61000-4-2)
- High Bandwidth (1.1 GHz Typical)
- Packaging (Pb-free & Green): - 10-contact, TDFN (ZE10)

#### **Applications**

- Routes Signals for USB 1.0, 1.1, and 2.0
- Mobile Industry Processor Interface (MIPI) Signal Routing

#### **Pin Configuration**



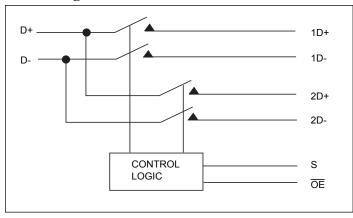
#### Description

The PI3USB221 is a high-bandwidth switch specially designed for the switching of high-speed USB 2.0 signals in handset and consumer applications, such as cell phones, digital cameras, and notebooks with hubs or controllers with limited USB I/Os. The wide bandwidth (1.1 GHz) of this switch allows signals to pass with minimum edge and phase distortion. The device multiplexes differential outputs from a USB host device to one of two corresponding outputs. The switch is bidirectional and offers little or no attenuation of the high-speed signals at the outputs. It is designed for low bit-to-bit skew and high channel-to-channel noise isolation, and is compatible with various standards, such as high-speed USB 2.0 (480 Mbps).





#### **Block Diagram**



## **Pin Description**

Name	Description	
OE	ctive LOW, Output enable	
S	Select input	
D	OM port	
nD	/O for USB data path (port 1 and port 2)	

#### **Truth Table**

S	ŌĒ	Function
X	Н	Disconnect
L	L	D = 1D
Н	L	D = 2D





#### ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

Over operating free-air temperature range (unless otherwise noted)

		–0.5V to 4.6V
V <sub>IN</sub> Control Input Voltag	e Range <sup>2, 3</sup>	0.5V to 7V 0.5V to 7V
V <sub>I/O</sub> Switch I/O Voltage	Range <sup>2, 3, 4</sup>	–0.5V to 7V
IIK Control Input Clamp	Current ( $V_{IN} < 0$ )	–50mA
II/OK I/O Port Clamp Cur	rrent ( $V_{I/O} < 0$ )	–50mA
II/O ON-state Switch Cur	rent <sup>5</sup>	±120mA
Continuous current throu $\theta_{JA}$ Package Thermal Imp		±100mA
TLLGA Package .		
TDFN Package		
T <sub>stg</sub> Storage temperature	range	65 to 150°C

#### Notes:

- 1. Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2. All voltages are with respect to ground, unless otherwise specified.
- 3. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 4. VI and VO are used to denote specific conditions for VI/O.
- 5. II and IO are used to denote specific conditions for II/O.
- 6. The package thermal impedance is calculated in accordance with JESD 51-7.

#### **Recommended Operating Conditions**<sup>1</sup>

Symbol	Description	Parameter	Min.	Max.	Unit
V <sub>DD</sub>	Supply voltage		2.3	3.6	
V <sub>IH</sub>	High-level control input voltage	$V_{DD} = 2.3 \text{ V to } 2.7 \text{ V}$	1.4	-	V
		$V_{DD} = 2.7 \text{ V to } 3.6 \text{ V}$	1.3	-	
V <sub>IL</sub> L	Low-level control input voltage	$V_{DD} = 2.3 \text{ V to } 2.7 \text{ V}$		0.6	
		$V_{DD} = 2.7 \text{ V to } 3.6 \text{ V}$		0.6	
V <sub>I/O</sub>	Data input/output voltage		0	5.5	1
TA	Operating free-air temperature		-40	85	°C

Note:

1. All unused control inputs of the device must be held at VDD or GND to ensure proper device operation.





## **ELECTRICAL CHARACTERISTICS**

#### Over operating free-air temperature range (unless otherwise noted)

Parame	eter	r Testing Conditions			Тур.	Max.	Unit	
V <sub>IK</sub>		$V_{DD} = 3.6V, 2.7V, I_I = -18 \text{ mA}$				-1.8	V	
I <sub>IN</sub>	Control Inputs	$V_{DD} = 3.6V, 2.7V, 0V, V_{IN} = 0V$ to $3.6V$				±1		
I <sub>OZ</sub> <sup>3</sup>		$V_{DD} = 3.6V, 2.7V, V_{IN} = V_{DD}$ or GN $V_{O} = 0V$ to 3.6V, $V_{I} = 0V$ , Switch O				±1		
Lonn		$V_{DD} = 0V$	$V_{\rm I/O} = 0V \text{ to } 3.6V$			±2		
I <sub>(OFF)</sub>		v DD - 0 v	$V_{I/O} = 0$ to 2.7V			±1		
I <sub>CC</sub>		$V_{DD} = 3.6V, 2.7V, V_{IN} = V_{DD} \text{ or } GN$ I <sub>I/O</sub> = 0 V, Switch ON or OFF	ND,			50	μA	
		$V_{DD} = 3.6V, 2.7V, V_{IN} = V_{DD}$ or GND, Switch disabled, ( $\overline{OE}$ in high state)				2		
DI <sub>CC</sub> <sup>4</sup>	Control	L Control		$V_{DD} = 2.7V$ , S sweeps from 1.4V to 3.3V, OE/ = 0V			15	
	Inputs		$V_{DD} = 2.7V$ , OE/ sweeps from 1.4V to 3.3V, S = 0V			0.75		
C <sub>IN</sub>	Control Inputs	$V_{DD} = 3.3V, 2.5V, V_{IN} = 3.3V \text{ or } 0V$			1	2	E	
Cio(OFF)		$V_{DD}$ = 3.3V, 2.5V, $V_{IN}$ = 3.3V or 0V, Switch OFF			2	4	pF	
C <sub>io(ON)</sub>		$V_{DD}$ = 3.3V, 2.5V, $V_{IN}$ = 3.3V or 0V, Switch ON			5	6		
r <sub>ON</sub> <sup>5</sup>		$V_{DD} = 3V, 2.3V$	$V_{I} = 0V, I_{O} = 30 \text{ mA}$			6		
ION		$v_{\rm DD} - 5v, 2.5v$	$V_{I} = 2.4V, I_{O} = -15 \text{ mA}$			6		
Drov		$V_{DD} = 3V, 2.3V$	$V_{I} = 0V, I_{O} = 30 \text{ mA}$		0.2		Ω	
Dr <sub>ON</sub>	<u>v UU - 5 v, 2.5 v</u>	$V_{\rm I} = 1.7 V, I_{\rm O} = -15 \text{ mA}$		0.2				
TON/ (III)		$V_{DD} = 3V, 2.3V$	$V_{I} = 0V, I_{O} = 30 \text{ mA}$		1			
rON(flat)		י נ., 2.5 י	$V_{I} = 1.7V, I_{O} = -15 \text{ mA}$		1			

Notes:

1. VIN and IIN refer to control inputs. VI, VO, II, and IO refer to data pins.

2. All typical values are at  $V_{DD}$  = 3.3 V (unless otherwise noted),  $T_A$  = 25°C.

3. For I/O ports, the parameter IOZ includes the input leakage current.

4. This is the increase in supply current for each input that is at the specified TTL voltage level, rather than VDD or GND.

5. Measured by the voltage drop between the input and output terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two terminals.

# **DYNAMIC ELECTRICAL CHARACTERISTICS**

over operating range,  $T_A = -40^{\circ}$ C to 85°C,  $V_{DD} = 3.3 \text{ V} \pm 10\%$ , GND = 0V

Symbol	Parameter	Test Conditions	Typ. <sup>(1)</sup>	Unit
X <sub>TALK</sub>	Crosstalk	$R_{\rm L} = 50\Omega, f = 250 \text{ MHz}$	-40	dB
O <sub>IRR</sub>	OFF isolation	$R_{\rm L} = 50\Omega, f = 250 \text{ MHz}$	-41	uБ
BW	Bandwidth (-3 dB)	$R_L = 50\Omega$	1.1	GHz

Note:

1. For Max or Min conditions, use the appropriate value specified under Electrical Characteristics for the applicable device type.

17-0003





Symbol	Parameter		Min.	Typ. <sup>(1)</sup>	Max.	Unit
t <sub>pd</sub>	Propagation Delay <sup>2,3</sup>			0.25		
t <sub>ON</sub>	Line enable time	S to D, nD			125	ns
		OE to D, nD			100	
t <sub>OFF</sub> Lin	Line dischle time	S to D, nD			12	
	Line disable time	OE to D, nD			12	
t <sub>SK(O)</sub>	Output skew between center port to any other port <sup>2</sup>			0.1	0.2	
t <sub>SK(P)</sub>	Skew between opp $(tPHL - tPLH)^2$	osite transitions of the same output		0.1	0.2	

Notes:

1. For Max or Min conditions, use the appropriate value specified under Electrical Characteristics for the applicable device type.

2. Specified by design

3. The switch contributes no propagational delay other than the RC delay of the on resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25 ns for 10-pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interactions with the load on the driven side.

# **SWITCHING CHARACTERISTICS** over operating range $T_A = -40^{\circ}C$ to $85^{\circ}C$ , $V_{DD} = 3.3$ V $\pm 10^{\circ}M$ GND = 0V





### **Application Information**

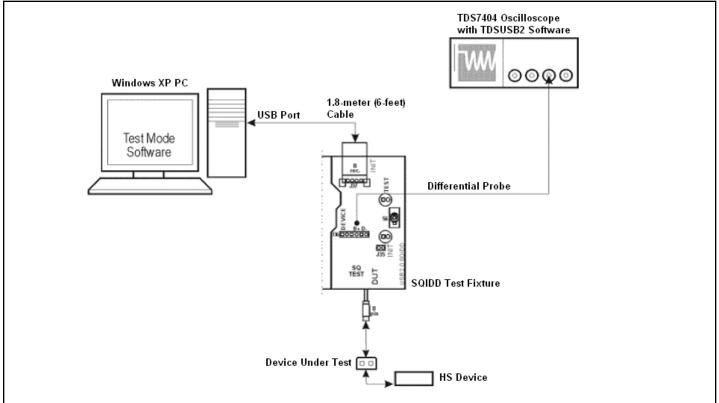
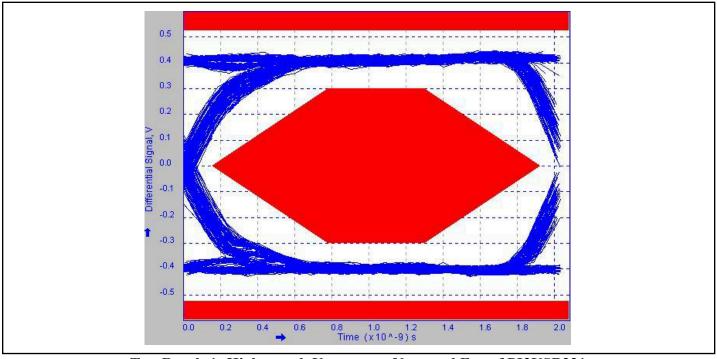


Figure 1: HS Eye Test Setup

#### **Test Result**

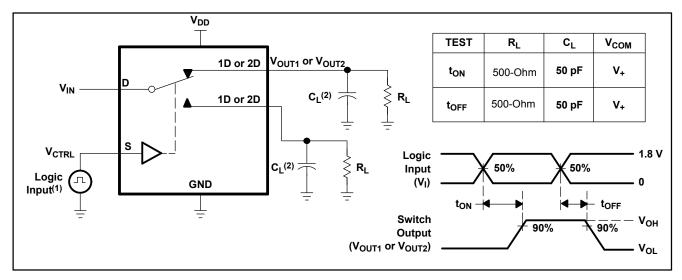


Test Result 1: High-speed, Up-stream, Near-end Eye of PI3USB221



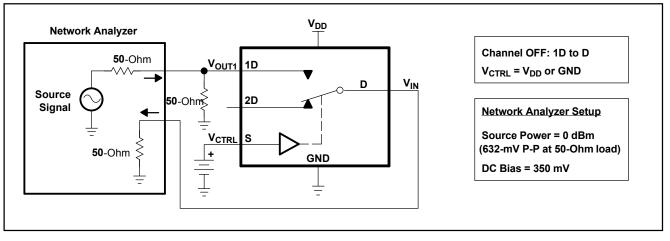


#### **Parameter Measurement Information**



<sup>(1)</sup> All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50-Ohm, t<sub>r</sub> < 5 ns, t<sub>f</sub> < 5 ns.  $^{(2)}$  C<sub>L</sub> includes probe and jig capacitance.

Figure 2. Turn-On (t<sub>ON</sub>) and Turn-Off Time (t<sub>OFF</sub>)



#### Figure 3.OFF Isolation (O<sub>ISO</sub>)





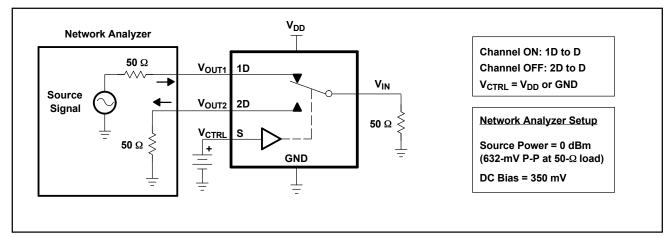
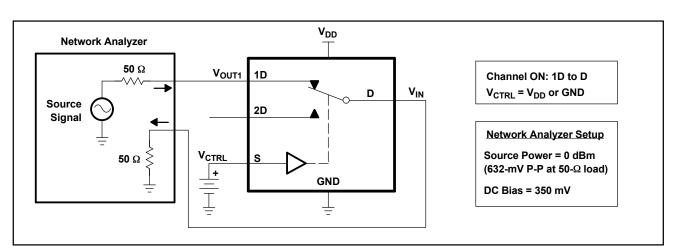
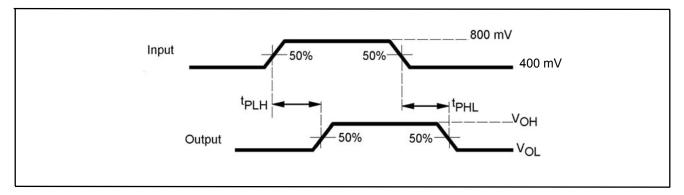


Figure 4. Crosstalk (X<sub>TALK</sub>)



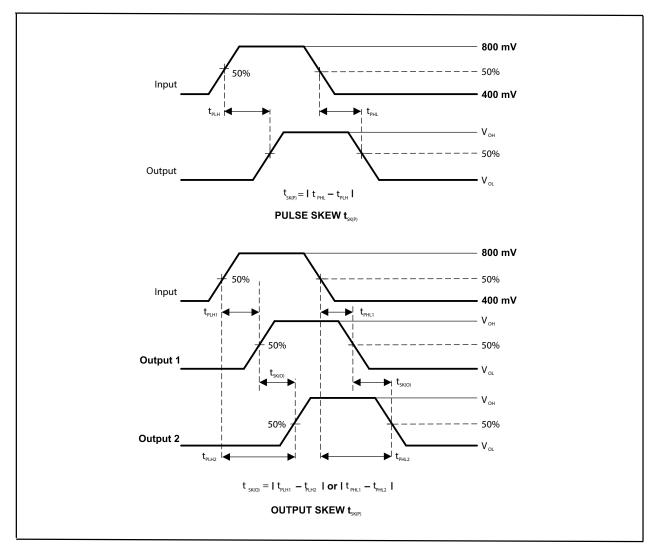
#### Figure 5. Bandwidth (BW)



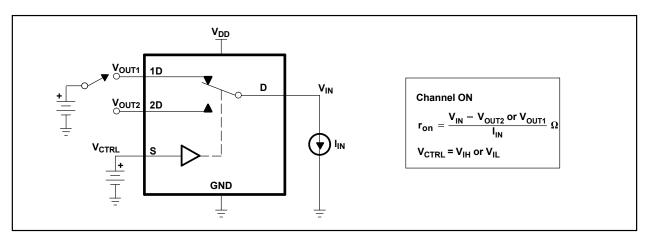
#### **Figure 6. Propagation Delay**







#### Figure 7. Skew Test



#### Figure 8. ON-State Resistance (ron)





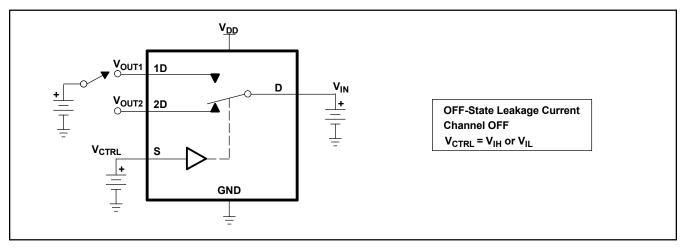


Figure 9. OFF-State Leakage Current

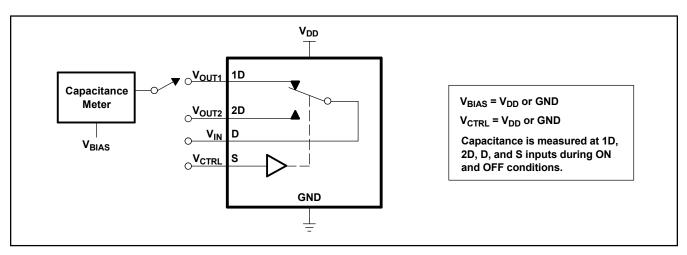
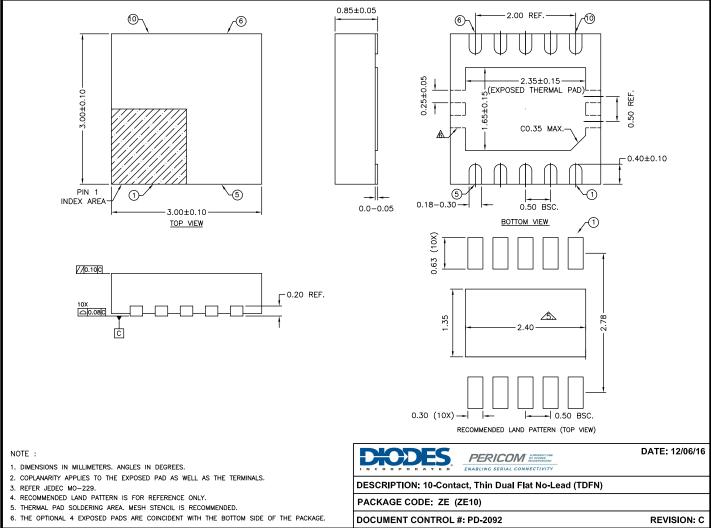


Figure 10. Capacitance





### **Packaging Mechanical: 10-Contact TDFN**



16-0275

Note: For latest package info, please check: http://www.pericom.com/support/packaging/packaging-mechanicals-and-thermal-characteristics/

# **Ordering Information**<sup>(1-3)</sup>

Ordering Code	Package Code	Package Description
PI3USB221ZEEX	ZE	10-Contact, Thin Dual Flat No Lead (TDFN), Tape & Reel

#### Notes:

1. Thermal characteristics can be found on the company web site at www.pericom.com/packaging/

2. E = Pb-free and Green

3. Adding an X suffix = Tape/Reel





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